

FDPF680N10T N-Channel PowerTrench[®] MOSFET 100 V, 12 A, 68 m Ω

Features

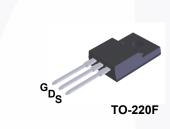
- R_{DS(on)} = 54 mΩ (Typ.) @ V_{GS} = 10 V, I_D = 6 A
- · Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

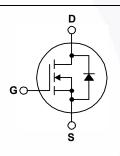
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench[®] process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- Consumer Appliances
- LCD/LED/PDP TV
- Synchronous Rectification
- Uninterruptible Power Supply
- Micro Solar Inverter





MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

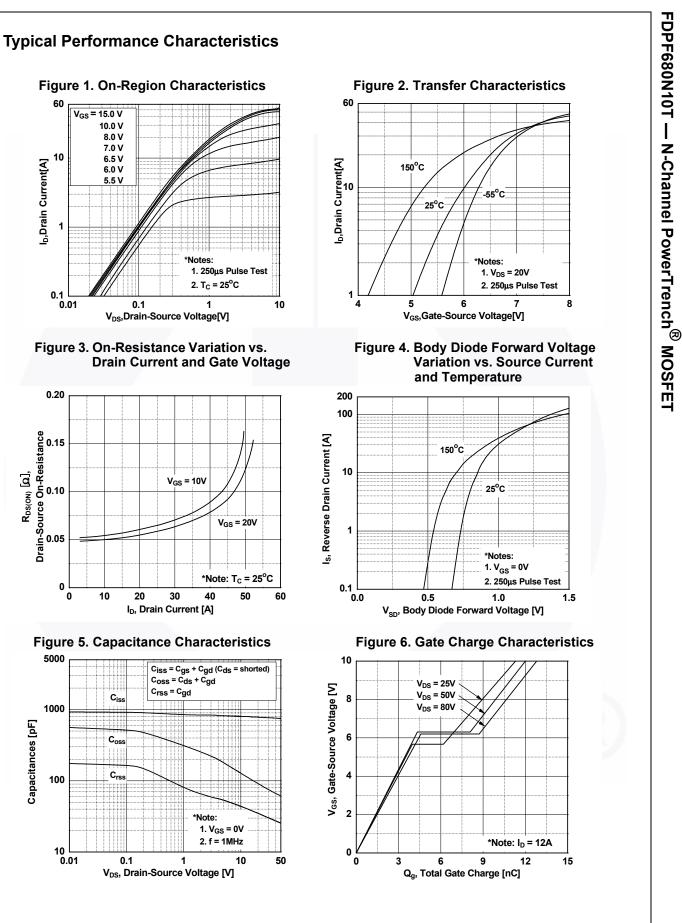
Symbol	Parameter			FDPF680N10T	Unit	
V _{DSS}	Drain to Source Voltage			100	V	
V _{GSS}	Gate to Source Voltage		±20	V		
ID	Drain Current	- Continuous (T _C = 25 ^o C)		12		
	Drain Current	- Continuous (T _C = 100 ^o C)		7.6	Α	
I _{DM}	Drain Current	- Pulsed	(Note 1)	48	А	
E _{AS}	Single Pulsed Avalanche Energy (Note 2)			50.4	mJ	
dv/dt	Peak Diode Recovery dv/dt (Note 3)		13.0	V/ns		
P _D	Devuer Dissinction	$(T_{\rm C} = 25^{\rm o}{\rm C})$		24	W	
	Power Dissipation	- Derate Above 25°C		0.19	W/ºC	
T _J , T _{STG}	Operating and Storage Temperature Range			-55 to +150	°C	
TL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 Seconds			300	°C	

Thermal Characteristics

Symbol	Parameter	FDPF680N10T	Unit
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	5.2	°C/W
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	0/10

		Package	Packing Method	Reel Size	Тар	e Width	Qua	ntity	
		TO-220F	220F Tube N/A		N/A		50 units		
Electrica	l Char	acteristics T _c = 25°C	C unless ot	herwise noted.					
Symbol		Parameter		Test Condit	ions	Min.	Тур.	Max.	Unit
Off Chara	cteristic	S			4				1
BV _{DSS}	Drain to Source Breakdown Voltage		e I	I _D = 250 μA, V _{GS} = 0 V, T _C = 25 ^o C		100	-	-	V
ΔBV _{DSS} /ΔTJ		own Voltage Temperature		$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		-	0.1	-	V/ºC
I _{DSS}		Coencient		V _{DS} = 100 V, V _{GS} = 0 V		-	-	1	
	Zero Gate Voltage Drain Current			$V_{\rm DS} = 100 \text{ V}, V_{\rm GS} = 0 \text{ V}, T_{\rm C} = 150^{\circ}\text{C}$			-	500	μA
I _{GSS}	Gate to Body Leakage Current			$V_{\rm GS} = \pm 20 \text{ V}, \text{ V}_{\rm DS} = 0$		-	-	±100	nA
On Charac	teristic	S							1
V _{GS(th)}	Gate Th	reshold Voltage	١	V _{GS} = V _{DS} , I _D = 250 μ	ιA	2.5	3.5	4.5	V
R _{DS(on)}	Static D	rain to Source On Resistan	ce '	V _{GS} = 10 V, I _D = 6 A		-	54	68	mΩ
9 _{FS}	Forward	d Transconductance	١	V _{DS} = 10 V, I _D = 12 A		-	26	-	S
Dynamic Characteristics C _{iss} Input Capacitance		,	V _{DS} = 50 V, V _{GS} = 0 V	/	-	750	1000	pF	
C _{oss}		Capacitance		$v_{DS} = 50 \text{ V}, v_{GS} = 0 \text{ V},$ f = 1 MHz		-	60	80	pF
C _{rss}		e Transfer Capacitance				-	25	40	pF
Q _{g(tot)}		ate Charge	,			-	13	17	nC
Q _{gs}	Gate to	Source Gate Charge		V _{DS} = 80 V, I _D = 12 A V _{GS} = 10 V	,		4	-	nC
Q _{gd}	Gate to	Drain "Miller" Charge			(Note 4)	-	4	-	nC
Switching	Charac	teristics							
	Turn-On	n Delay Time		V_{DD} = 50 V, I _D = 12 A, V _{GS} = 10 V, R _G = 10 Ω		-	13	36	ns
t _{d(on)}	Turn-On	Rise Time				-	19	48	ns
t _{d(on)} t _r		f Delay Time				-	18	46	ns
· · /	Turn-Off				(Note 4)		6	22	ns
t _r		f Fall Time			(Note 4)	-	U		
t _r t _{d(off)} t _f	Turn-Off	,			(Note 4)	-	0		
t _r t _{d(off)} t _f	Turn-Off	f Fall Time	rce Diode I	Forward Current	(Note 4)	-	-	12	A
t _r t _{d(off)} t _f Drain-Sou	Turn-Off rce Dioc Maximui	f Fall Time de Characteristics	Diode Forw	ard Current	(Note 4)	-	-	12 48	A A
t _r t _{d(off)} t _f Drain-Sou	Turn-Off rce Dioc Maximu Maximu Drain to	Fall Time de Characteristics m Continuous Drain to Sour m Pulsed Drain to Source D Source Diode Forward Volt	Diode Forw	vard Current V _{GS} = 0 V, I _{SD} = 12 A		-	-		
t _r t _{d(off)} t _f Drain-Sou I _S I _{SM}	Turn-Off rce Dioc Maximum Maximum Drain to Reverse	f Fall Time Je Characteristics m Continuous Drain to Sour m Pulsed Drain to Source D	Diode Forw tage	ard Current		-	-	48	Α

4. Essentially independent of operating temperature typical characteristics.



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10 L 0.01

60

l_b,Drain Current[A] D

0.1

0.20

Drain-Source On-Resistance 01.0 01.0 01.0

0

5000

1000

100

Capacitances [pF]

0

10

Ciss

Cos

Crs

0.1

20

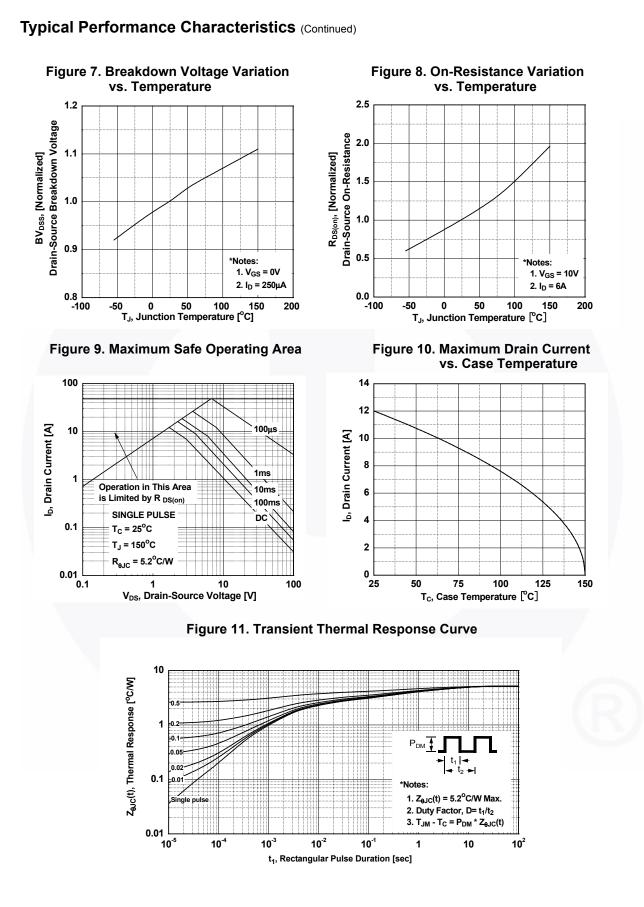
R_{DS(ON)} [Ω],

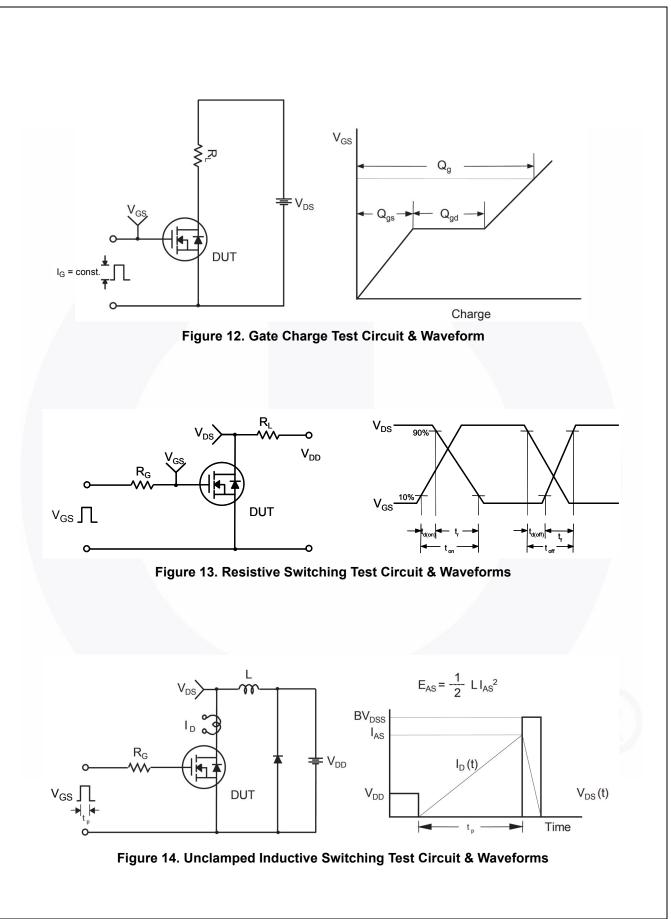
V_{GS} = 15.0 V 10.0 V 8.0 V

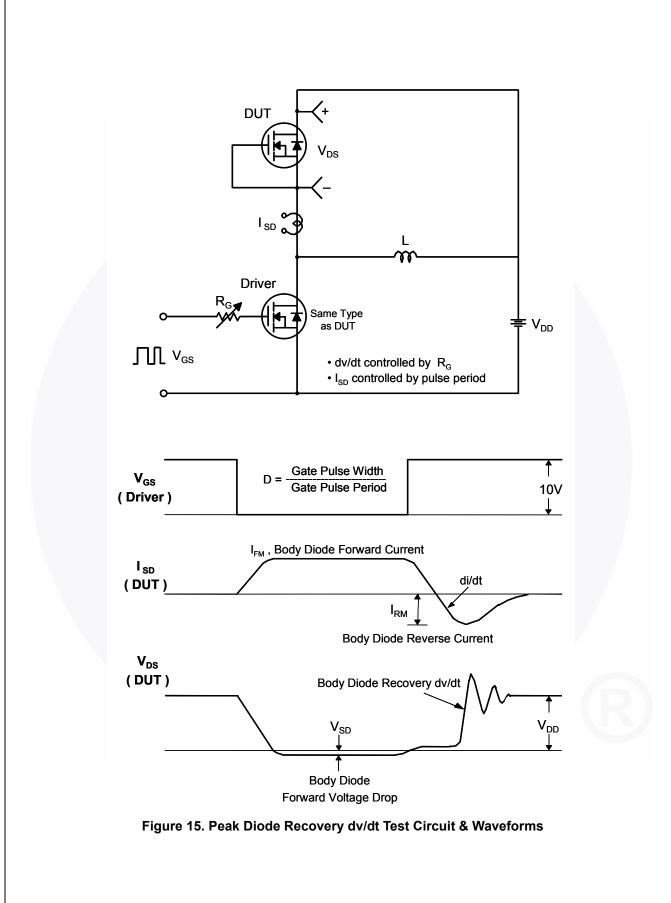
7.0 V 6.5 V

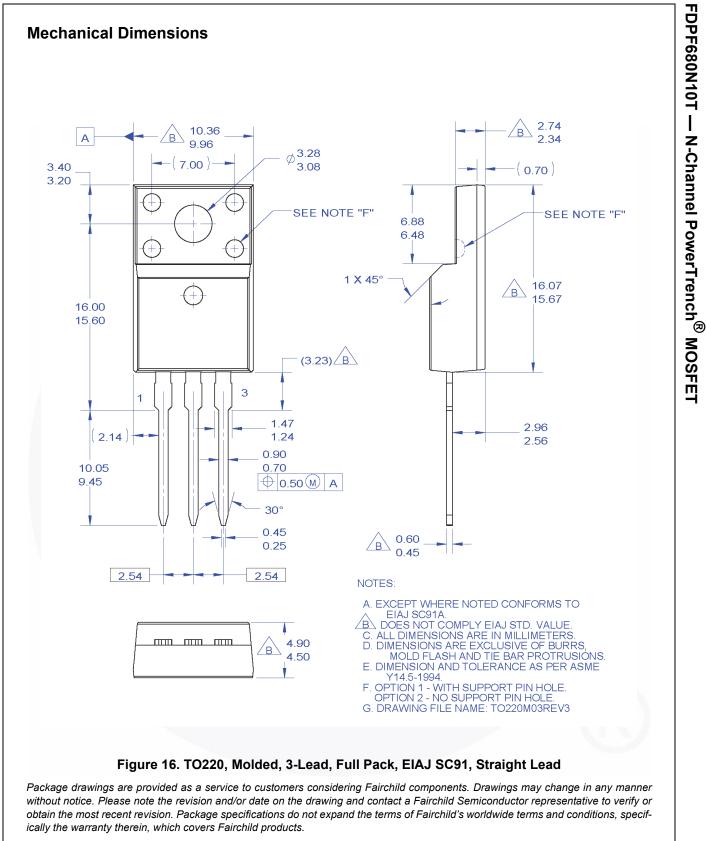
6.0 V 5.5 V

0.1









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